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Please note that the forward-looking statements contained herein are based on the current market situation and the Company's management direction, and they are subject to change according to the shifts in the future market environment and business strategy





세계와 함께 성장하는 일류기업 이수페타시스

To be a World Wide Company ISUPETASYS



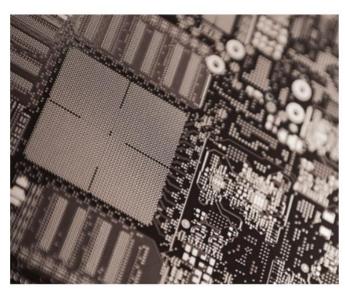


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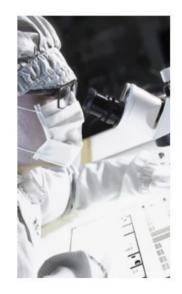
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O2 New Plant Investment Plan





01





Market Outlook & Company Plan

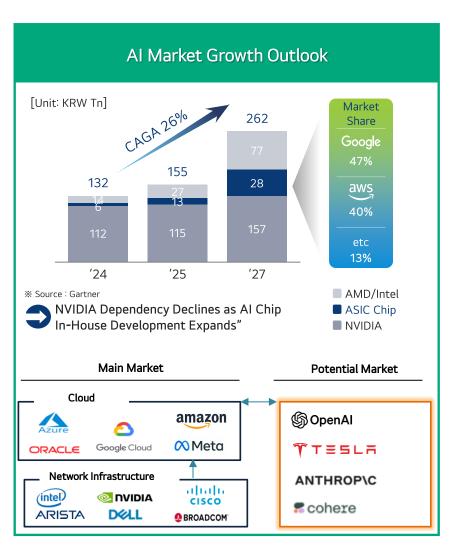
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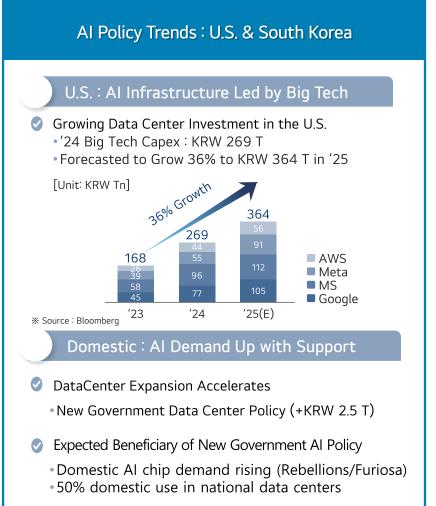




01 Al Market Trends and Outlook

"Al Growth Driven by Leading U.S.- Based Network Infrastructure Companies"



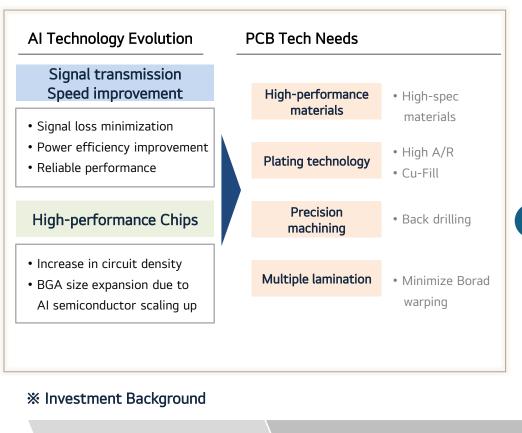






O2 PCB Technology Trends Driven by AI Evolution

"Increasing demand for enhanced PCB performance driven by growing AI chip demand"



Key Product Line changes

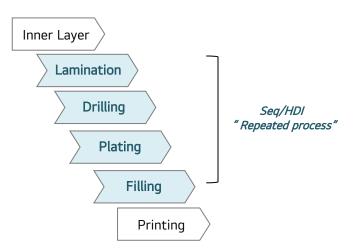
VIPPO (Existing)

Seq/HDI

(New Porduct)

- Layers : 22 ~ 30L
- Thickness : 3.2T
- A/R:13:1
- Stub: 7±5mil, 6±4,mil
- Layers : 40L ↑
- Thickness : 5.0T ↑
- A/R: 22:1
- Stub∶ Max 7mil↓

→ Higher core process complexity and repetitions



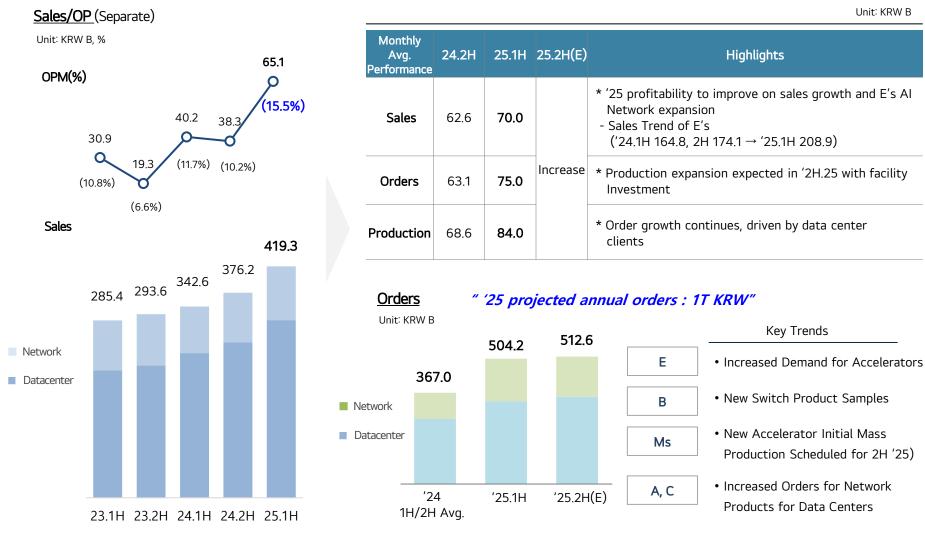
- AI Technology Evolution
- –Increasing Demand for HighPerformance Semiconductors
- Increasing PCB Technical Complexity
- -Accelerator : VIPPO \rightarrow Seq/HDI
- -Switch: VIPPO → Seq/HDI





03 Sales & Operating Profit(ISUPetasys_korea)

"Data center demand grows, profitability up with Company E's AI network sales"

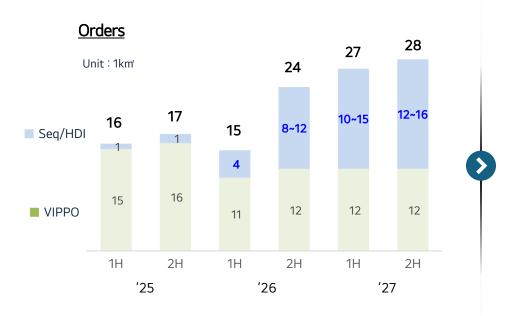






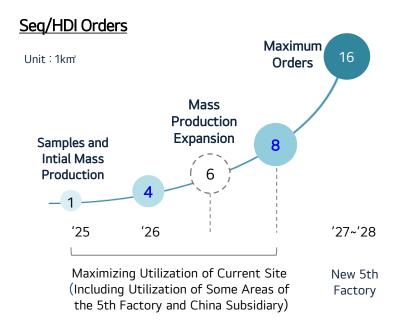
04 Increased Demand for PCB(Seq/HDI)

"AI-based Seq/HDI Mass Production Transition Expected to Accelerate After '26"



Seq/HDI Mass Production Key Plans by Key Clients

		Product Line	Mass Production Timeline			
		Product Line	'25.1H	'25.2H	'26	
	E	AI Accelerator				
	В	AI Accelerator				
Existing	Ms	AI Accelerator				
Clients	Ме	Switch				
	Cel	Switch				
	Α	Switch				
New	Am	AI Accelerator				
Clients	0	TBD				







02

New Factory Investment Plan

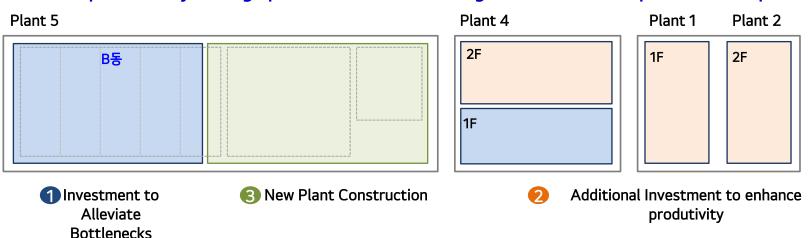
- 01. New Facility Investment Plan('25~'28)
- 02. Projected Image of completed Plant 5
- 03. Investment Schedule
- 04. Investment Impact





01 New Facility Investment Plan('25~'28)

"Increase productivity through partial investment in stages before the completion of the plant 5.



Category	[Phase1] Investment to Alleviate Bottlenecks	[Phase2] Additional Investment to enhance produtivity	[Phase3] New factory construction
Investment	Investment to Alleviate Bottlen enhance produtivity	 Establishment of high-value-added production system centred on multiple layers 	
Direction	• Factory 5 (Building B+ Plant 4, 1F factory	• Utilise spare space in factories 1-4	Integrated relocation of ne plantsMaximum automation implementation
Maximum sales (CAPA)	• 85.0 KRW B/M (KRW 1T/Y)	• 95.0 KRW B/M (KRW 1.1T/Y)	• 125.0 KRW B/M (KRW 1.5T/Y)
Major Investment processes	• Lamination, Drill, Plating	• Drill, Plating	• Total Process
Mass production Target	• Q4.'25	• 2H.'26	Q3.'27(Completed)'28 Facility relocation completed





O2 Projected Image of completed Plant 5







03 Investment Schedule

"Stage 3 Investment: 3 Years, Stage 1 Mass Production in Nov '25"

Schedule

Phase 1: Nov '25 (Mass Production)

			Duration		2025				20	26			20	27	
			Duration	2Q	3Q	41	J	1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q
	Demolition and Design	2M													
	5th	Construction / Utilities	4M												
Phase 1	Factory B	Planting / Drilling	11M												
		Outer Layer / Inspection 7M													
	4th	Drill Reloaction, etc	11M												
Phase 2	1~4th	Outer Layer / Plating, etc	12M												
		Preliminary Preparation	6M												
Phase	Phase 3 5th Foctory Build	Construction Works	19M												
		Environment / Utilities	16M										Co	Aug. mpleti	on
		Equipment Installation	-												

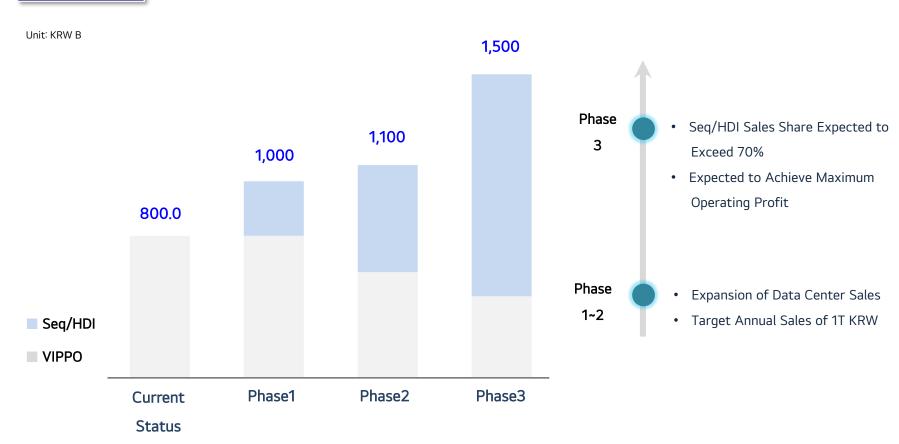




04 Investment Impact

"1.5T KRW Annual Sales Target After Phase 3 Investment"

Sales Outlook

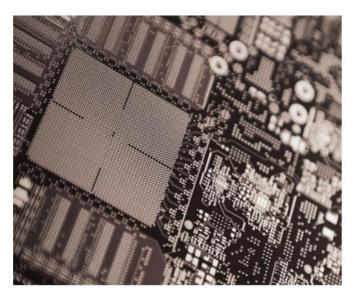






03





Company overview

- 01. ISU PCB Group Introduction
- 02. Global PCB Suppliers Ranking
- 03. Summary financial statements (consolidated/separate)
- 04. ESG Evaluation and Certification





01 ISU PCB Group Introduction

Product Applications Sales / Operating Profit

(Unit: KRW B)

ISU **Petasys** (Korea)



- · 1989
- · Korea(Daegu)
- · Ultra-High layer (20L↑)
- App.
- Al Accelerator
- Network/Server

ISU **Petasys** Hunan (China)



- · 2013
- · China
- · MLB (~18L)
- · App.
- Network/Server
- Automotive

ISU **Petasys** Corp (USA)



- · 2001
- · USA
- · Sales Corporation (Suspension of Production Division, 2Q.'24)

		'21	'22	'23	'24	'25.1H
ISU Petasys	Sales	363.5	497.2	579.0	718.7	419.3
(Korea)	ОР	43.7	96.4	50.2	78.5	65.1
ISU Petasys	Sales	92.1	142.7	121.9	152.4	103.8
Hunan (China)	ОР	2.4	20.3	15.2	18.4	18.3
ISU Petasys	Sales	32.2	37.1	35.6	28.3	10.7
Corp (USA)	ОР	0.8	(0.6)	(3.8)	4.5	6.1
Consolida	Sales	469.6	642.9	675.3	836.9	493.9
ted	ОР	46.9	116.6	62.2	101.9	89.8





02 Global PCB Suppliers Ranking

"Specialized in the manufacture of multi layer PCB (18 Layers1)"

Global MLB PCB(18L1) Suppliers in '23

(Prsimark VHMLB PCB Market Share)

Rank	Company	18L+ Sales (M\$)
1	ISU Petasys (Korea)	362
2	TTM (US)	330
3	WUS (Taiwan)	214
4	Shennan (China)	115
5	Gold Circuits (Taiwan)	96
6	Others	200
(Sh	ingyi, Victory Giant, Unimicor	n, Tripod)
Leading	suppliers	1,318

World Top PCB makers in '24

Rank	Company	Sales (M\$)
1	Zhen Ding	5,340
2	Unimicron	3,594
3	Dongshan	3,451
4	Nippon Mektron	2,504
5	Shennan Circuit	2,492
6	TTM	2,443
7	Compeq	2,256
37	ISU Petasys	614
Top 40 Tota	al	56,958

*Source: RCD Strategic Advisors Report(11/2024)

*VHML: Very High Multi Layer

*Source: Prismark Report (1Q25)





O3 Summary financial statements (Consolidated/Separate)

<u>Financial Status / Income Statement</u> (Consolidated)

Unit: KRW B

<u>Financial Status / Income Statement</u> (Separate)

Unit: KRW B

	4005	2025		4005	2005		1025	2025		1025	2025
	1Q25	2Q25		1Q25	2Q25		1Q25	2Q25		1Q25	2Q25
Current	503.3	731.1	Sales	252.5	241.4	Current	409.2	630.5	Sales	209.6	209.7
Non-current	303.8	345.4	Cost of sales	186.1	185.5	Non-current	313.1	371.6	Cost of sales	158.7	164.5
Assets	807.1	1,076.4	Gross profit	66.4	55.9	Assets	722.3	1,002.1	Gross profit	50.9	45.2
Current	364.8	327.9	SG&A	18.7	13.9	Current	283.4	257.1	SG&A	17.6	13.4
Non-current	85.3	82.7	Operating profit	47.7	42.1	Non-current	79.7	77.2	Operating profit	33.4	31.8
Liabilities	450.0	410.6	Non-operating income	13.8	17.8	Liabilities	363.1	334.3	Non-operating income	25.6	25.0
Share capital	63.2	73.4	Non-operating expenses	15.0	19.2	Share capital	63.2	73.4	Non-operating expenses	13.5	18.1
Capital surplus	81.0	351.7	Pre-tax profit	46.5	40.7	Capital surplus	94.8	3,65.4	Pre-tax profit	45.4	38.7
Retained earnings	201.1	233.6	Income tax	8.2	9.3	Retained earnings	212.1	244.5	Income tax	7.1	7.4
Equity	357.1	665.8	Net income	38.3	31.4	Equity	359.1	667.8	Net Income	38.3	31.3

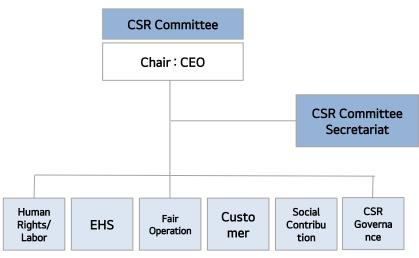




04 ESG Assessment and Certification

CSR Committee Organization Chart

*CSR: Corporate Social Responsibility



[&]quot;Published the first CSR report in 2015 and have disclosed CSR performance annually.

ESG assessment results: A (1H.'25)

Category		'25	'24	'23	Remark
Sustin	1H	A	А	А	Overall H2 '24 Ranking 189 th (based on 1,287 companies)
Best	2H	-	А	BB	4 th in sector ('64 companies)

X Sustinvest '24 Performance Report Details

Category	Score	Sector Average	Weighting
Environment (E)	73.9	34.1	25%
Social (S)	81.8	42.3	35%
Governance (G)	58.9	53.1	40%

Multiple certifications



Major awards



"TOP Direct component supplier" ('19)



"Excellence in Technology" ('19)



"Supplier of the year" ('08) (first in PCB industry) "Excellence In Quality" ('10)



"Supplier of the year" ('09)

[→] Committed to transparent and socially responsible corporate management."







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